

Nb3Sn Accelerator Magnets Insulation Review

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History

Nb₃ Sn Hexapole

Magnet Construction Procedure

 Insulate conductor with glass bread.
 Imprograde bread with PMMA

(perspec) 1. Wind - bonding layers with

\$20' feed treatment. a. Assemble in southall-

inprogradion model countrancially farm parts. 5. Feasive perspectively with pre-

reaction hoot treatment at 390°C in vacuum

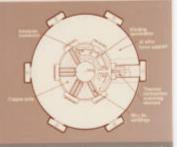
5. Form Nb, Sn- 2 weeks in excusm at 650°C.

C Imprograde with eccary main



Magnet Conductor 1900 Michael Barrents in a betrain matrix 49 annes asserts of pure copper.

E) of wriding 50mm Conductorises 22x1Nmm ODofwrding 100mm Pecking/lactor 72.5 Langthowedi 450mm Luma pole 132 Bockses 40x11mm Conductor ingflippier/DM

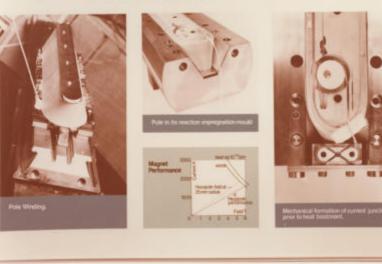


gret sector shaving pole interconnection and support acture details.

Filamentary Nb3Sn Hexapole Magnet manufactured by wind – react route - tested 1976

Extended studies of insulation techniques for Nb3Sn dipoles ~ 1980

Insulation Studies within the NED initiative - 2004





- Brief review of insulation techniques for Nb3Sn accelerator magnets Wind and React route
- Consider the critical issues and the limitations in relation to the the technical challenge presented by future high field dipoles
- Outline proposal of studies to be undertaken within the NED Programme
- Look forward to see how we might improve performance and reliability by improving knowledge of materials



Conventional

- Glass/ quartz tape or braid
 - mica film
- Removal of Sizing
- Wrapping or sleeving of cable
- Coil Winding
- Heat treatment
- Transfer to Impregnation Mould
- Impregnation with epoxy



- Novel Innovative
- Improvements in sizing resizing
 - LBNL Palmitic acid
 - Next steps follow "Conventional" epoxy impregnation
- Replacement of organic sizing with inorganic or ceramic precursor CEA Saclay/LBNL
 - Full bonding by ceramic route removes impregnation this is the target



Insulation Techniques

Innovative

•Glass tape is impregnated with a thick layer of ceramic precursor

• Ceramic penetrates entirely the fibers

•Tape can be used to wrap the cable in a conventional way

•Standard Nb3sn heat treatment for reaction also achieves heat treatment of the ceramic to give a structurally complete coil

Courtesy of Francoise Rondeaux CEA Saclay





- Electrical Insulation Strength
 - -Do not require high breakdown voltage
 - typically 100 200 V/turn during quench
 - Conductor spacing of 0.4mm = 250 500
 V/mm
 - -Do require high electrical integrity
 - Failure will have serious consequences because of the high stored energy density



What are the Key Issues (2)

- Thickness is important for 3 reasons
- Current density
 - 1.5mm cable 0.15mm ins 20% J reduction
- Thermal contraction
 - Pre-compression
- Modulus of the winding
 - Movement under magnetic loads
- However, very thin insulation will have little tolerance for cable imperfections or inclusions and may be prone to damage at high loads – so spacing may be a safety factor
- In the limit a robust insulation with high integrity is more important than 10% current density



- Mechanical properties
 - Cable taping flexibility tight bends
 - Winding abrasion bending clamping
 - Heat treatment 1 wk >650C
 - Assembly loading collaring 200MPa
 - Cooldown thermal stresses
 - Operation compressive loading shear



- Radiation Hardness
 - Increasingly important for high beam intensities
- Thermal conductivity
 - High would be nice
- Porosity to helium
 - Would be nice

CCLRC Conventional Insulation – Limitations (1)

• Glass or quartz tape or braid

Thickness

- S Glass tape usually >100micron double layer with overlap will give >200micron – effect on overall current density is significant
 - Can be reduced by single wrap with mica sheet UT
- Tape thickness limitation is not so much a fundamental property but more one of commercial availability
- Braid offers potential advantages in thickness
 - Sleeving is only possible for short lengths otherwise a specialist machine is needed
- Linear wrapping can also offer the potential for thickness reduction
- Basic material is fragile for insulating and winding of a large cable
 - especially so when sizing is removed

CCLRC Conventional Insulation – Limitations (2)

• Magnet heat treatment in stages

- removing sizing is not easy and some residue will remain – effect on electrical properties
- There is a risk of damage during heat treatment expansion movements – will be increased for long coils
- After full heat treatment the glass is extremely fragile – great care is required in any handling before impregnation
- Impregnation with epoxy
 - relatively complex process cost for production
 - helium is excluded from the winding stability



- Programme of insulation development for 15T large aperture dipole
- 2 R&D strands
 - Conventional RAL
 - Innovative CEA building on existing programme
- Programme phases
 - Insulation Review and Specification
 - Programme definition
 - Materials selection
 - Processing routes to evaluate
 - Test Programme definition and execution



- What target properties should we will be aiming for :
 - Thickness
 - target total 150-200 microns
 - Electrical
 - Turn to turn voltage ~ 200 V $\,$ safe to 800V
 - ~2-3 kV/mm in insulation laminate
 - Thermal contraction
 - Transverse 3-4X10e-3
 - Mechanical
 - Compressive transverse working 150-200MPa
 - Fracture properties ??; Tensile; Shear
 - Porosity
 - Radiation Hardness



NED Test Programme

- Generic Tests
 - Materials and process route characterisation using basic resin and insulation laminate samples
 - Electrical insulation thermal contraction
 - Mechanical: tensile compressive shear work of fracture
- Special test samples
 - Conductor+insulation stack to simulate winding
 - Compression
 - Short beam shear



Mechanical Testing



- •100kN Servo-hydraulic machine
- •Standard tests 300K,77K,4.2K
- •Tensile, Compression
- •Short beam shear
- •3-point bend
- •Shear/compression
- •With extensometry
- •Comprehensive control and data acquisition software
 - Elwyn Baynham RAL



Materials Characterisation

•DMA (Digital Mechanical Analyser)

- •Measures response of a material to a stress (dynamic or static) as a function of temperature or time
- •LN2 to 500°C
- •3-point bend, tension, parallel plate
- •Rapid Characterisation of resins eg Tg

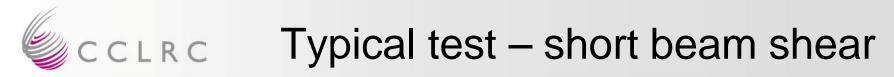




Materials Characterisation

- •DSC (Dynamic Sampling Calorimeter)
- •Calorimetric device
- •Reaction kinetics, transition temperatures
 - -Very fast ramp rates









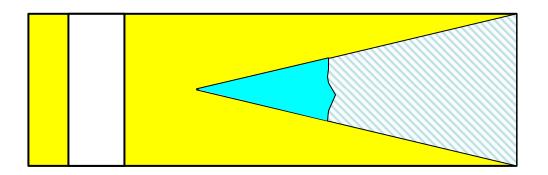
- Aim to devote a part of the programme to study new materials, new processes and new tests which could offer improved performance
 - -Tests work of fracture
 - Resins increased toughness improved thermal contraction matching
 - Insulating materials with high temperature potential

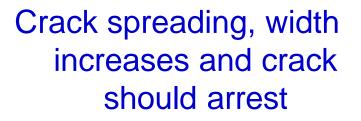


- Significance of Fracture Properties
 - Cracks induce quenches
 - Cracks depend upon:
 - Size of local stress field
 - Magnetic loads (design issue)
 - Thermal contraction (materials issue)
 - Cure shrinkage stresses (materials issue)
 - Toughness of insulation system (materials issue)
 - How are insulation materials related to stability and magnet performance
 - How do the properties of ceramic bonded systems compare with resin bonded



Chevron compact tension specimen to arrest cracks in brittle materials







- Dendritic hyperbranched polymers (HBP)
- "Dendritic hyperbranched polymers have been shown to be able to double the interlaminar fracture resistance of epoxy-based composites and to reduce the internal stress level by as much as 80% with only 10phr of modifier. These property improvements were obtained without affecting the viscosity, and thus the processibility, nor the glass transistion temperature of the epoxy resin" - Mexxenga et al, Comp Sci Tech 2001



- Nanofillers (clay)
- "Layered clays were used as nanoparticle fillers in fiber-reinforced polymeric materials. [epoxy composites] Transverse cracking...in response to cryogenic cycling was significantly reduced when nanoparticle fillers were used at concentrations much lower than those used for traditional fillers [e.g. 5phr]...Overall this work showed that nanoclays can easily be used to modify traditional fiber-reinforced composite materials and enhance their resistance to thermal cycling induced stresses" -Timmerman, Comp Sci Tech 2002



- Insulation for Nb3Sn magnets remains one of the most challenging issues limiting the engineering exploitation of Nb3Sn conductors
- Design, processing route, materials properties, and end product are totally interdependent
 - Developing materials is not an isolated activity
 - Materials technology is always advancing look at the techniques for processing HTS – so there are potential solutions out there
- In the next few months we will be looking at new technologies as we define the R&D programme and tests for NED
- We welcome input on techniques and tests from co-workers in the field
- Within the limits of the programme we would very much like to develop samples and do benchmark tests with collaborators